IPC ASSOCIATION ELECTRONIC	Material Com © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved international and Pan-American copyright conventions.		All rights reserved un	nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly we level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsible.								
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				Materials and	ials and Mfg Information				
upplier	r Information													
Company name* Company				npany unique ID			Unique ID Authority				Response Date*			
onsemi											2025-06-07			
ontact N	ame	Title - Contact			F	Phone - Contact*				Email - Contact*				
Product-E	Env-Stewards	Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com				
uthorize	d Representative*	Title - Representative			F	Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards Product Enviro Complia				iro Compliance	NA.			P			Product-Env-Stewards@onsemi.com			
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufacturing S	Manufacturing Site		UOM	Unit Type	
	1N5913BRLG ZEN SUR30 R		ZEN SUR30 REG	G 3W 3.3V		2025-06-07		CNP		361.01	mg	Each		
	cturing Process Informa		Terminal Base	Alloy	-STD-020 MS	I. Poting	Pook Proce	ss Pody Tomp	oratura May Tima (t Pagk Tompo	watura Numb	or of Poflow Cv	olos	
8		CU Allov NA			L Kaung	Peak Process Body Temperature Max T O C 30				Peak Temperature Number of Reflow Cycles seconds 3				
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	information regarding materia	1	1£ 4											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and/Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required f Requester) and click on Submit Form to ha		Accepted" on the Supplier Acceptance drop-dow	n. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.67	mg	Supplier	Silicon (Si)	7440-21-3		2.67	mg
Die Attach Solder	12.67	mg	Supplier	Silver (Ag)	7440-22-4		0.3168	mg
			A	Lead (Pb)	7439-92-1	7a	11.7198	mg
			Supplier	Tin (Sn)	7440-31-5		0.6335	mg
Lead Frame	198.45	mg	В	Nickel (Ni)	7440-02-0		2.183	mg
			Supplier	Copper (Cu)	7440-50-8		196.267	mg
Mold Compound-Black	139.28			Metal Hydroxide	proprietary data		6.964	mg
			Supplier	Carbon Black (C)	1333-86-4		1.3928	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		104.46	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		13.928	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		12.5352	mg
Plating	7.94	mg	Supplier	Tin (Sn)	7440-31-5		7.94	mg